

ZXTN5551FL 160V, SOT23, NPN High voltage transistor

Summary

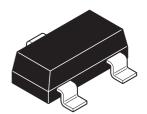
BV_{CEO} > 160V

 $BV_{EBO} > 6V$

 $I_{C(cont)} = 600 mA$

 $P_D = 330 \text{mW}$

Complementary part number ZXTP5401FL

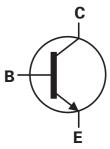


Description

A high voltage NPN transistor in a small outline surface mount package.

Features

- 160V rating
- SOT23 package

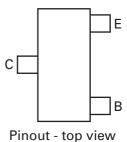


Applications

· High voltage amplification

Ordering information

Device	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTN5551FLTA	7	8	3000



Device marking

N51

Absolute maximum ratings

Parameter	Symbol	Limit	Unit
Collector-base voltage	V _{CBO}	180	V
Collector-emitter voltage	V _{CEO}	160	V
Emitter-base voltage	V _{EBO}	6	V
Continuous collector current ^(a)	I _C	600	mA
Power dissipation at T _{amb} =25°C ^(a)	P _D	330	mW
Linear derating factor		2.64	mW/°C
Operating and storage temperature range	T _j , T _{stg}	-55 to 150	°C

Thermal resistance

Parameter	Symbol	Limit	Unit
Junction to ambient ^(a)	$R_{\Theta JA}$	379	°C/W

NOTES:

(a) For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

Electrical characteristics (at T_{amb} = 25°C unless otherwise stated)

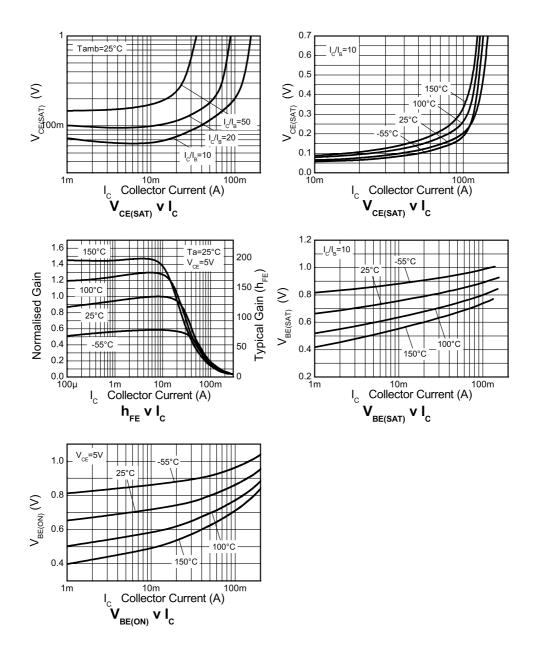
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV _{CBO}	180	270		V	I _C = 100μA
Collector-emitter breakdown voltage (base open)	BV _{CEO}	160	200		٧	I _C = 1mA (*)
Emitter-base breakdown voltage	BV _{EBO}	6	7.85		V	$I_E = 10\mu A$
Collector cut-off current	I _{CBO}		<1	50	nA	V _{CB} = 120V
				50	μΑ	V _{CB} = 120V, T _{amb} = 100°C
Collector-emitter saturation	V _{CE(sat)}		65	150	V	$I_C = 10 \text{mA}, I_B = 1 \text{mA}^{(*)}$
voltage			115	200	V	$I_C = 50 \text{mA}, I_B = 5 \text{mA}^{(*)}$
Base-emitter saturation	V _{BE(sat)}		760	1000	mV	I _C = 10mA, I _B = 1mA ^(*)
voltage			840	1200	mV	$I_C = 50 \text{mA}, I_B = 5 \text{mA}^{(*)}$
Static forward current	h _{FE}	80	135			$I_C = 1mA, V_{CE} = 5V^{(*)}$
transfer ratio		80	145	250		I _C = 10mA, V _{CE} = 5V ^(*)
		30	65			$I_C = 50 \text{mA}, V_{CE} = 5V^{(*)}$
Transition frequency	f _T		130		MHz	I _C = 10mA, V _{CE} = 10V, f = 100MHz
Output capacitance	C _{OBO}			6	pF	V _{CB} = 10V, f = 1MHz ^(*)
Small signal	h _{FE}	50		260		$I_C = 10 \text{mA}, V_{CE} = 10 \text{V},$ $f = 1 \text{kHz}^{(\dagger)}$
Delay time	t _(d)		95		ns	V _{CC} = 10V, I _C = 10mA, I _{B1} =
Rise time	t _(r)		64		ns	I _{B2} = 1mA
Storage time	t _(s)		1256		ns	
Fall time	t _(f)		140		ns	

NOTES:

^(*) Measured under pulsed conditions. Pulse width ${\leq}300\mu s;$ duty cycle ${\leq}2\%.$

^(†) Periodic sample test only

Typical characteristics



ZXTN5551FL

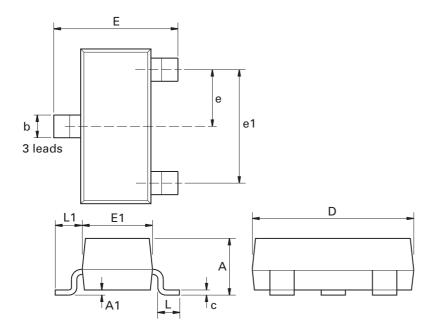
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Package outline - SOT23



Dim.	Millin	neters	Inc	hes	Dim.	Millimeters		Inches	
	Min.	Мах.	Min.	Max.		Min.	Max.	Min.	Max.
Α	-	1.12	-	0.044	e1	1.90	NOM	0.075	NOM
A1	0.01	0.10	0.0004	0.004	Е	2.10	2.64	0.083	0.104
b	0.30	0.50	0.012	0.020	E1	1.20	1.40	0.047	0.055
С	0.085	0.20	0.003	0.008	L	0.25	0.60	0.0098	0.0236
D	2.80	3.04	0.110	0.120	L1	0.45	0.62	0.018	0.024
е	0.95	NOM	0.037	NOM	-	-	-	-	-

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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Issue 1 - August 2007 © Zetex Semiconductors plc 2007 www.zetex.com

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